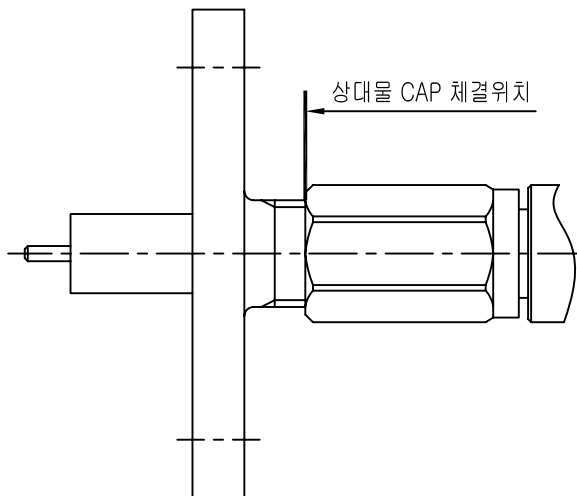
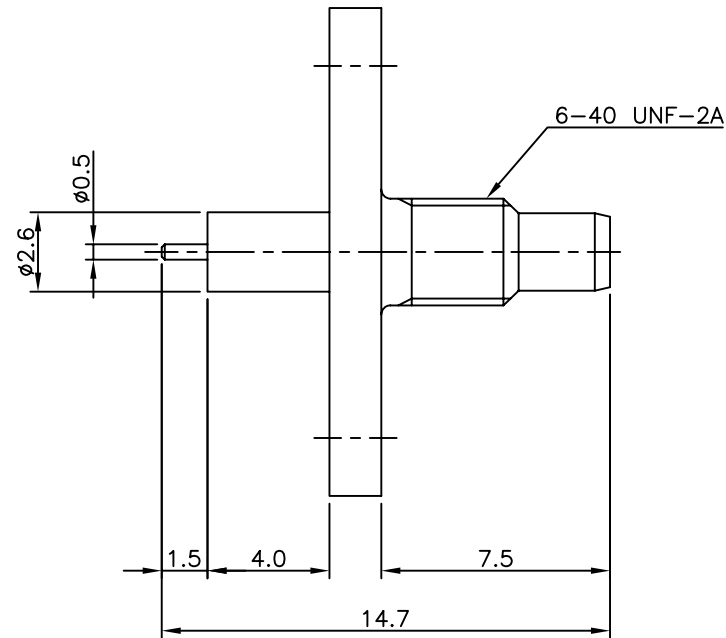
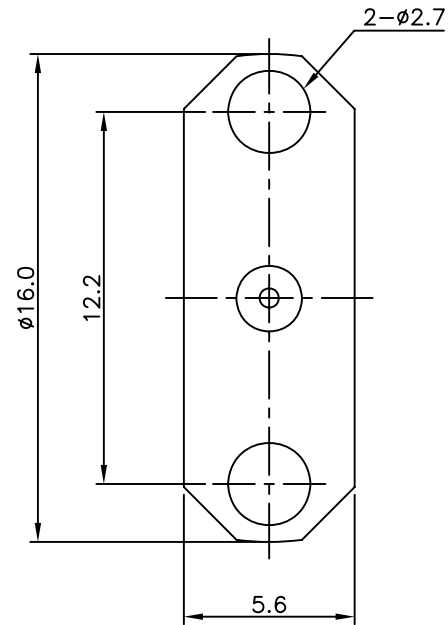


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
IR	Initial Registration	S.Y.EUN	I.C.KIM	2021.01.25.
1	[설번No.202102-0005] 조립후 절연체 돌출 방지로 인한 길이 변경	S.Y.EUN	I.C.KIM	2021.02.15.



3	INSULATOR	1	TEFLON		DIN03187-N/1
2	CONTACT	1	MBsBD C3604BD-F	Gold Plate	DCT04180-5/1
1	BODY	1	MBsBD C3604BD-F	Nickel Plate	DBD04685-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal	DATE 2021. 01. 25.		 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle	APPROVED BY	I.C.KIM	
MATERIAL		CHECKED BY		TITLE SSMC50 SOLDER END JS-2H
		DRAWN BY	S.Y.EUN	
FINISH		SCALE	4/1	 A4
		UNIT	mm	
		DWG NO.	CN03969-7/1	SHEET 1 of 1
		REVISION	1	